## Microstructure and Texture Development during Solid Consolidation Recycling of Ti-6AI-4V

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### Abstract

Ti-6AI-4V machining chips were recycled using equal channel angular pressing (ECAP). The microstructural and texture evolution of the recycled Ti-6AI-4V have been investigated using scanning electron microscopy, electron backscattered diffraction and transmission electron microscopy. For samples consolidated at 500 °C with a back-pressure of 100 MPa, the as-pressed density reached up to 99.9% after 8 passes. Pronounced grain refinement was also observed with increasing number of passes. The morphology of the grains has been changed from elongated and coarse to equiaxed and ultrafine as the number of passes increases. Strong textures were also introduced during multiple passes via B<sub>c</sub> route. Texture has been developed with basal planes parallel to the inclination direction which is at 21° of the extrusion direction. After 4 and 8 passes, basal planes were rotated towards the transverse direction. No oxide can be detected at the chip-chip boundaries when the Ti-Al-4V machining chips was consolidated at 500 °C. When the sample was processed at 550 °C, significant grain growth and clear oxide layers at the chip-chip interface were observed. In addition, the c-axis were rotated towards the longitudinal direction due to the non-basal slip activity. TEM observation revealed the  $\langle \vec{a} + \vec{c} \rangle$  dislocations presence in the 550 °C ECAP-processed sample.

**Keywords:** Ti-6AI-4V; Microstructure; Texture evolution; Low temperature solid consolidation recycling, Equal channel angular pressing

#### 1. Introduction

Ti-6Al-4V is widely used in aerospace and biomedical applications due to its high specific strength, anti-corrosion property and bio-compatibility <sup>[1-3]</sup>. However, the relatively high price of Ti-6Al-4V alloy limits its broader applications. Traditional manufacture process of Ti-6Al-4V parts usually involves large amount of machining leading to substantial material waste. Conventional recycling methods involve re-melting and re-casting, which are high energy consumption processes. Recently, solid-state recycling with severe plastic deformation (SPD) process has been proposed as an energy-saving method for recycling various metallic machining chips mainly for softer metals and alloys, such as Mg alloys <sup>[4; 5]</sup>, Al alloys <sup>[6; 7]</sup> and pure Ti <sup>[8]</sup>. In addition, SPD, such as equal channel angular pressing (ECAP) recycling has also been reported successfully demonstrated in harder alloys system, for example Ti-6Al-4V <sup>[9-12]</sup>. The ECAP recycled product can achieve 99.0% density without any post processing <sup>[11]</sup>.

ECAP is a well-established SPD method to produce ultrafine grained bulk materials <sup>[13; 14]</sup>. During ECAP, simple shear deformation occurs in a narrow region at the intersecting plane of the inlet and outlet channels <sup>[15]</sup>, as marked as shear zone in Fig. 1. Since the sample is pressed through a die with the cross-sectional dimension unchanged, very large accumulative strain is possible to be imposed via repetitive passes. In this way, significant grain refinement and strong texture can be introduced. Both microstructure and crystallographic texture evolution strongly depend on the ECAP process parameters (e.g. prescribed processing route, temperature and number of passes) <sup>[16-19]</sup>.

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Studies have shown that texture has pronounced influence on mechanical properties, especially for hexagonal close packed (HCP) materials due to the anisotropy <sup>[20-23]</sup>, i.e. the mechanical properties of materials vary significantly with the loading directions. Several studies have been made on the microstructure and texture evolution of bulk ECAP-processed pure Ti alloys <sup>[24-27]</sup> and a few on Ti-6AI-4V <sup>[28]</sup>. The evolution of the texture of ECAP-processed pure Ti was reported to be originated mainly from twinning in the first pass at the processing temperature of 350 °C<sup>[29]</sup>. However, in the subsequent passes, the twinning was suppressed and the deformation was mainly accommodated by dislocation slips. Nevertheless, the active slip system during deformation in Ti-6AI-4V was under controversy in ECAP process: it was either depending on the specific route at the processing temperature of 350 °C <sup>[29]</sup> or predominantly basal slip irrespective of routes <mark>at</mark> the ECAP temperature of 400 °C <sup>[30]</sup>. Very limited works have been reported for the texture evolution of ECAP-processed Ti-6AI-4V. Due to the addition of Al, it was expected that the twinning activity would be minimised in Ti-6Al-4V <sup>[31]</sup>. The current study revealed the possibility of producing bulk Ti-6AI-4V directly from machining chips at moderate temperature with refined grain structure. The microstructure evolution such as grain size and texture of the ECAP recycled Ti-6AI-4V after multiple passes (1, 2, 4 and 8 passes) and at different temperatures (500°C and 550°C) will be discussed in this paper.

## Experimental materials and procedure

The raw material used in this investigation was machining chips from a Ti-6AI-4V round bar with a diameter of 80 mm  $^{[32]}$ . In order to avoid contamination, coolant and lubricant were not used during the machining process. The machining chips were of ~180 µm thickness and saw-tooth shaped. According to our previous study, the machining chips consisted of the

lamellar microstructure inherited from the bulk Ti-6AI-4V and primary shear zones induced during machining<sup>[11]</sup>. The detailed microstructure characterization of the initial machining chips has been reported elsewhere <sup>[11]</sup>.

Before ECAP, Ti-6Al-4V chips were pre-compacted into cylindrical bars with a diameter of 10 mm and a length of ~70 mm by a hydraulic press and then wrapped with Al foil. The wrapped and pre-compacted specimens were subjected to ECAP via route Bc up to 8 passes at the temperature of 500 °C accompanied with a back-pressure of 100 MPa. In addition, samples pressed with a back-pressure of 250 MPa at temperatures of 500 °C and 550 °C for a single pass were used for comparison. The pressing speed was also kept constant at 4 mm/min, and molybdenum disulphide (MoS<sub>2</sub>) was used as lubricant in the ECAP channels. The ECAP die has an angle ( $\phi$ ) of 90° between two channels and a relief angle ( $\psi$ ) of ~36° at the intersection, as shown in Fig. 1. This design gives a shear strain of ~1 after each passage through the die.



Fig. 1 Schematic cross section of the ECAP die, for which  $\phi$  and  $\psi$  equal to 90° and ~36°, respectively. The extrusion direction (ED), longitudinal direction (LD), transverse direction (TD), shear direction (SD) and normal to shear direction (NSD) of the ECAP process are also indicated.

Specimens for TEM examination were mechanically ground to a thickness of  $\sim 100 \ \mu m$ , and then Ar<sup>+</sup> ion milled for perforation. TEM images and

corresponding selected area diffraction (SAD) patterns were obtained in a JEOL 2000FX operated at 200 kV.

The texture of the LD-ED plane (as shown in Fig. 1) was measured by a Carl Zeiss (LEO) 1530VP field emission gun (FEG) scanning electron microscope (SEM) fitted with a HKL Nordlys F high speed electron backscatter diffraction (EBSD) camera. The EBSD scans were done at an acceleration voltage of 20 kV with a 0.2 µm step size and scan area of 100 × 100 µm. The coordinate systems of the as-pressed specimen extrusion direction (ED), longitudinal direction (LD) and shear direction (SD) is shown in Fig. 2(a). It should be noted that the shear direction is 45° to the longitudinal direction when the relief angle  $\psi$  of the die is 0°. In the current die,  $\psi$  is of 36°, therefore the shear direction is of ~69° to the longitudinal direction. The relative directions used in pole figures are shown in Fig. 2 (b) with direction normal to the shear direction (NSD), inclination direction (ID) and normal to inclination direction (NID) added to facilitate the texture description in the discussion section.



Fig. 2 (a) The coordinate system of as-pressed specimen, and (b) the reference coordinate system used in the pole figures, the dotted line and arrows indicating the shear directions of the current die design.

#### 2. Experimental results and discussions

2.1 Effect of number of passes on microstructural and texture formation of recycled Ti-6AI-4V

The microstructure feature was firstly illustrated by optical microscopy. Fig. 3a shows an optical micrograph of a recycled Ti-6AI-4V after single pass. It indicates that the chips inclined at ~21° with respect to the ED after one pass of the ECAP process, which is defined as the inclination direction (ID) in this study. The inclination direction of the chips with respect to the ED is near the theoretical shear flow line (i.e. the shear direction SD) which is about 21° to the ED for a die with  $\phi = 90^{\circ}$  and  $\psi = 36^{\circ}$  <sup>[33]</sup> and it also agreed with the the experimental results presented elsewhere <sup>[30; 34; 35]</sup>. The inclination angle remains unchanged in the subsequent passes when the samples are processed with route Bc as shown in Fig 3b. The inclination angle is still ~21° after four passes.



(a)

(b)

Fig. 3 Optical micrograph showing the Ti-6Al-4V chips after a) the first pass, b) the fourth pass. Chips are orientated at an inclination angle of ~21° with respect to the ED after the first and fourth pass.

Figs. 4 (a) to (d) illustrate the texture evolution of the recycled Ti-6Al-4V after 1, 2, 4 and 8 ECAP passes in  $\{0002\}$  and  $\{10\overline{1}0\}$  pole figures. To facilitate the discussion, the ideal fibre texture identified by Beausir et al. <sup>[36]</sup> is shown in Fig. 4(e). The five ideal shear texture components (P, B, Y, C<sub>1</sub> and C<sub>2</sub>) have been referred to in the analysis for HCP crystals under simple shear, for example Ti alloys <sup>[30; 37-39]</sup>, although it is obtained from pure magnesium <sup>[36; 40]</sup>.

As shown in Fig. 4(a), the basal poles were titled towards the direction inclining an angle of ~21° with the LD. This implies that the basal plane was almost aligned with the ID of ECAP. As evident by the {1010} pole figure, grain orientation with  $<10\overline{1}0>$  directions parallel to the ID is formed after one pass, and the development of three clusters at an angle of ~60° interval as shown in the pole figure represent the crystallographic symmetry of  $\{10\overline{1}0\}$  family of planes. A schematic diagram of HCP crystal representing the orientation with respect to the reference coordinate system is shown in Fig. 5. Comparing with the ideal fibres, it is apparent that the textures developed after the first pass are the B fibre as indicated by both  $\{0002\}$  and  $\{10\overline{1}0\}$  pole figures; nevertheless, the basal and prismatic poles drifted from the ideal position (SD is 45° from ED in the ideal case). This is likely because the die used in the current study had a corner angle of ~36°, while the ideal textures were simulated using relief angle of 0° [36]. Although the applied back-pressure could facilitate to narrow the ECAP shear zone, the area of deformation still fanned out during processing. This fibre texture is typical in ECAP-processed bulk Ti-6AI-4V <sup>[20; 28]</sup> and many other HCP materials <sup>[36; 41-43]</sup>, although with  $\pm$  5° deviations of the inclination direction (ID) which is the imposed shear direction for the current die used in this study.

As the machining chips before ECAP were compacted similar to briquetting, all chips were assumed to be aggregated randomly, thus the initial texture is regarded weak. The strong B fibre texture after the first pass as shown in Fig. 4(a) is mainly attributed to basal slip activity during ECAP, because basal slip  $\{0001\}\langle 11\overline{2}0\rangle$  is the dominant deformation system in Ti-6AI-4V subjected to moderate-temperature ECAP <sup>[20]</sup>. This results in  $\{0002\}//$  ID texture. Although prismatic slip  $\{10\overline{1}0\}\langle 11\overline{2}0\rangle$  is usually considered as the easiest slip system to be activated in  $\alpha$ -Ti, during deformation the alloying elements like AI suppress the prismatic slip <sup>[44]</sup>. Furthermore, the critical resolved shear stress (CRSS) of

basal slip reduces faster than prismatic slip with increasing temperature <sup>[28; 45]</sup>. In the current experimental conditions (ECAP-processed at 500°C), the relative activity of basal slip is much higher than other deformation systems and it is agreed with the simulated results reported in the literature [28, 30].



Fig. 4 {0002} and {1010} pole figures of Ti-6Al-4V recycled at 500 °C with a back-pressure of 100 MPa after (a) 1, (b) 2, (c) 4,(d) 8 passes and (e) ideal fibres of Mg after ECAP with shear direction (SD) of 45° about longitudinal direction (LD) (modified after<sup>[36]</sup>).



Fig. 5 Schematic diagram of  $\alpha$ -Ti crystal after the first pass showing the basal plane parallel to the inclination direction (ID)

After the second pass, it can be seen that the consequent texture exhibits three peaks in the  $\{0002\}$  pole figure, as labelled in Fig. 4(b). In route B<sub>C</sub> the sample is rotated around the ED by 90° in the same direct after each pass. The strong texture component labelled as peak 1 after two passes is the P1 texture component, which is likely to inherit from the first pass, i.e. the B texture developed after the first pass was rotated 90° around ED, as illustrated in Fig. 6, resulting the c-axis about 17° away from TD. Peak 2 is attributed to the grain rotated by the imposed shear stress during the second pass, and hence a B texture. Peak 3 (deviated from P fibre texture) is formed due to the insufficient rotation of the B texture after first pass (i.e. {0002}//ID) <sup>[37]</sup>. Comparing the texture of ECAP-processed pure Ti measured by XRD, both peaks 1 and 3 were observed <sup>[30; 37]</sup>. The existence of peak 2 implies that for ECAP recycled Ti-6AI-4V chips, texture development differ to the bulk pure Ti is likely attribute to the different deformation mechanisms in Ti-6AI-4V [42]. The addition of alloying elements, constraint of chip boundaries and pressing temperature will affect the deformation mechanism. The corresponding  $\{10\overline{1}0\}$ pole figure after two passes shows the presence of an incomplete P1 fibre texture, as indicated by dotted lines in Fig. 4(b).

Fig. 4(c) shows that after 4 passes, the resulting {0002} texture is dominant by the B and P fibre textures with 10 - 20° spread. As shown in Fig. 4(d), it is observed that the basal texture after 8 passes is still dominated with the B and P fibres with a much smaller spread than that after 4 passes. The strongest texture, P<sub>1</sub> (peak 5) was found near the ideal position after 8 passes. Complementary with {1010} pole figures, it is obvious that after 4 and 8 passes, P fibre textures are sharpened, although the positions are slightly rotated from the ideal locations. The evolution of the texture development shows that B and P textures are the most commonly occurred among the five ideal shear texture components after the second pass and these fibre textures are sharpened with the increase in number of passes.



Fig. 6 Schematic diagram showing the rotation of  $\alpha$ -Ti crystal after 2 passes.

The most significant feature of the texture evolution after 4 and 8 passes is the rotation of c-axis towards the TD (P<sub>1</sub> texture). This resembles the texture evolution of ECAP-processed pure Ti at 400 °C <sup>[30]</sup>, although they only performed the ECAP experiments and simulations up to the 3rd pass and ignored the activity of twining in the simulation. For ECAP-processed pure Ti the twinning is an important mechanism to accommodate the deformation, especially in the first pass <sup>[29]</sup>, nonetheless, in the subsequent passes, the CRSS required to activate twinning is much larger than that required for activating dislocation slip in fine grain structure <sup>[29]</sup>. Eliminating of twinning

activities in the simulation of pure Ti is more applicable in the case of Ti-6AI-4V, because the addition of alloying elements (e.g. AI) in Ti will suppress the twinning deformation mechanism <sup>[31; 46; 47]</sup>. The only observation of twinning in ECAP-processed Ti-6AI-4V was reported by Yapici et al. <sup>[28]</sup>, where Ti-6AI-4V was pressed at 800 °C using route A. Based on the present experimental results, the plastic deformation during the ECAP is expected to be majorly accommodated by dislocation slips.

The microstructures of samples after different numbers of passes are also shown in TEM micrographs (Fig. 7). The microstructure after one pass (Fig. 7(a)) contains chains of elongated grains, as indicated by the arrows. These deformed grains are originated from the lamellar structure (with size about 3µm) of the initial machining chips as reported elsewhere [11]. As a result of the shearing during ECAP, the lamellae were refined and transverse grain boundaries formed due to the aggregation of dislocation cell walls. With further ECAP to 4 passes, as shown in Fig. 7(b), equiaxed grains with average size of ~70 nm in diameter were started developing, but some elongated grains remained (as indicated by the arrows). After 8 passes, it is observed that there is no further grain refinement, however, the elongated grains were eliminated and the microstructure is dominated by nano-scaled and equiaxed grains. Similar results have been reported in our previous paper <sup>[11]</sup>."

The schematic diagram of grain refinement mechanism during multiple-pass ECAP is illustrated in Fig 8. The grains elongated at the first pass and more equiaxed grains will form with subsequent passes until reaching an equilibrium state.



Fig. 7 TEM microstructure of recycled Ti-6AI-4V at 500 °C with a back-pressure of 100 MPa for (a) 1, (b) 4 and (c) 8 passes.



Fig. 8 Schematic diagram showing the grain refinement of recycled Ti-6AI-4V with the increase in number of ECAP passes. d is denoted the smallest width (~70 nm) of the lamella microstructure in the chips.

# 2.2 Effect of pressing temperature on microstructure and texture formation of recycled Ti-6AI-4V

Figs. 9(a) and (b) show the EBSD orientation maps of the samples after single pass with a back-pressure of 250 MPa at 500 °C and 550 °C, respectively. The sample processed at 500 °C had a relatively low EBSD indexing rate (Fig. 9(a)), because the quality EBSD patterns were poor in the regions consisting of ultrafine grains with high level of plastic strain. It is observed that the elongated grains were again parallel to the ID (Fig. 3). The increase in the processing temperature by 50 °C resulted in larger dynamic recovery and stress relief of the as-pressed sample, which has been indicated in the EBSD result with better indexing rate (Fig. 9(b)). In addition to ultrafine grains

(marked by ovals, regions 1 and 2), larger and elongated grains were found (indicated by arrows), unlike those which processed at lower back pressure and temperature (Figs 8 and 9 (a)). The average diameter of the ultrafine grains in regions 1 and 2 is  $\sim 250\pm60$  nm. The elongated grains have width ranged from 5 – 10 µm and possess orientation change within a grain as indicated by the arrows in Fig 9. The misorientation profiles in Fig. 10(a) and (b) suggest the misorientation within the elongated grains in both samples pressed at different temperatures are less than 15° indicating the existing of low angle grain boundaries in the deformed grain.



Fig. 9 EBSD orientation maps showing the microstructures of the recycled samples by single ECAP with a back-pressure of 250 MPa at: (a) 500 °C and (b) 550 °C. Post processing EBSD noise reduction was performed by extrapolating using the 5 nearest neighbours with a 5° angular tolerance.



Fig. 10 Misorienation profiles measured along:(a) line AB in EBSD map of sample pressed at 500 °C (Fig. 9(a)) and (b) line CD in EBSD map of sample pressed at 550 °C (Fig. 9(b)).

Due to the limited spatial resolution of EBSD, TEM was used to study the nano sized microstructures. In the samples processed at 500 °C, the lamellar structure of the machining chips which was about 5 microns is refined down to lamellae with a width of ~70 nm, and transverse sub-grain boundaries are observed within the lamellae, as indicated by arrows in Fig. 11(a). The equiaxed grains with an average size of ~70 nm are produced during the first pass (Fig. 11(b)). Such a bimodal structure in the single-pass sample has been reported in the previous research <sup>[11]</sup>. The coexisting of elongated and equiaxed  $\alpha$  grains implies that the shearing strain during the first pass has not effectively refined the initial microstructure. Apart from the dominated  $\alpha$  phase, lamellar  $\beta$  phase was also identified, as shown in Fig. 11(c): The EDS analysis (Al: ~3.04 wt.%; V: ~26.11 wt.%) and corresponding SAD pattern confirms that the lamellar structure was  $\beta$  phase. Compared to the initial  $\beta$  phase (Fig. 11(d)), the grain size is decreased from ~80 nm to ~40 nm. Similar result was obtained in bulk Ti-6AI-4V ECAP-processed at 600 °C to 800 °C, where the β lamellae were thinned after the first pass by fragmentation [34].



Fig. 11 Typical TEM microstructures developed during the single-pass ECAP at 500 °C with a back-pressure of 250 MPa: (a) lamellar structure, (b) equiaxed α grains with the inset showing the corresponding ring-shape SAD pattern, (c and d) β lamella with the inset of the corresponding SAD pattern.



Fig. 12 TEM images of Ti-6Al-4V recycled by single ECAP at 550 °C with a back-pressure of
 250 MPa: (a) equiaxed α grains, (b) abnormally large α grains, (c) β grain marked by the circle and (d) a chip/chip interface and corresponding SAD pattern.

| chip/chip interface (marked by the circle in Fig. 12(d)) of the specimen processed at 550 °C. |      |     |     |      |
|---|------|-----|-----|------|
| Element   | Ti   | ΑΙ  | V   | Ο    |
| Concentration (wt.%)  | 58.5 | 5.7 | 2.6 | 33.2 |

Table 1 Weight percentage of the chemical elements detected by EDS analysis at the

TEM micrographs show that the sample processed at 550 °C has a relatively coarser and heterogeneous microstructure (Fig. 12). The grain size of the  $\alpha$ phase was fallen into a wider range. Majority of the  $\alpha$  grains have diameter of  $\sim$ 300 nm (Fig. 12(a)), which is consistent with the EBSD results. In addition, some extra-large  $\alpha$  grains with diameter of ~600 nm were observed (Fig. 12(b)). The grain growth also occurred in  $\beta$  phase as marked by the circle in Fig. 12(c): an equiaxed  $\beta$  grain (V content of ~26.17 wt.%) with a diameter of ~100 nm. The chip/chip interface is shown in Fig. 12(d) and the bright field image indicates a layer of finer structure which is not observable in the sample pressed at lower temperature (500°C). The corresponding SAD and EDS analysis (Table 1) suggest that is an oxide layer. The two innermost continuous rings of the SAD pattern are contributed by ultrafine grained TiO<sub>2</sub><sup>[8]</sup>, and corresponding to the  $\{110\}$  and  $\{101\}$  rings of the tetragonal TiO<sub>2</sub>, as indicated in the inset of Fig. 12(d). The formation of oxide layers along the chip/chip boundaries or oxide particles within the matrix were reported in previous researches on solid state recycling of metallic chips <sup>[5; 9; 48]</sup>. The existence of oxide layers on machining chip surfaces was believed to be introduced during the machining process because of the substantial heat generation at the chip/tool interface <sup>[9]</sup>. However, in the current study, the oxide layer at the chip boundary was only observed in the sample processed at 550 °C. The thickness of the naturally formed oxide layer on titanium alloys is less than 5 nm <sup>[49]</sup>. Thus, it is plausible that the oxide layer in the samples pressed at 500 °C was too thin or has been fragmented to even finer oxide

particles and those could not be detected by TEM EDS. The present result indicates thicker oxide layer was formed at the chip/chip interface when the sample was pressed at 550 °C. The increase in temperature facilitated the formation of thicker oxide layer along the chip/chip interface. These oxide layers may be broken up into particles due to the severe plastic deformation during ECAP. The oxide dispersion strengthening (ODS) in ECAP-processed Mg and Ti alloys have been observed and partly responsible for the enhanced mechanical properties <sup>[5; 48]</sup>. The microhardness histograms of the samples ECAP-processed at 500 °C and 550 °C are plotted in Figs. 13(a) and (b), respectively. The red lines indicate the average hardness values. It is noticed that the degree of scattering for these two diagrams is almost identical; nonetheless, the sample pressed at 550 °C possessed a slightly higher average hardness than the sample pressed at 500 °C (384±21 HV vs. 359±14 Considering the relatively coarser HV). grains observed in the ECAP-processed sample at 550 °C, the hardness measurement seems to be contradicted to the Hall-Petch relation. In this case, the hardness enhancement in the 550 °C ECAP-processed sample may be due to the strengthening by the fine oxide dispersed within the matrix [45].



Fig. 13 The histograms showing the microhardness distributions of the samples after single ECAP pass with a back-pressure of 250 MPa at (a) 500 °C and (b) 550 °C.

Figs. 14(a) and (b) show {0002} pole figures of recycled Ti-6Al-4V after single pass with a back-pressure of 250 MPa at 500 °C and 550 °C, respectively.

Comparing the texture in Fig. 14(a) with the simulated ideal orientations (Fig. 4(e)), both B and P fibres were observed. In comparison to the single-pass recycled Ti-6AI-4V using a lower back-pressure of 100 MPa (Fig. 4(a)), the texture components are rotated towards the LD. This may be due to the activation of the non-basal slip systems when the applied back-pressure increased <sup>[50; 51]</sup>. The increase in back-pressure leads to a narrow plastic deformation zone (PDZ) <sup>[52]</sup>, making the ECAP process close to the simple shear model. The shearing force can aggravate the deformation heating during ECAP <sup>[53]</sup>, resulting in the reduced critical resolved shear stress (CRSS) for non-basal slip. In the sample processed at 550 °C, the basal poles are rotated further towards the LD (Fig. 14(b)). It is because the CRSS for non-basal slip systems was further reduced with increasing processing temperature.

TEM observation provides evidence of the non-basal slip activity of the sample pressed at 550°C. Fig. 15 shows the bright field images of dislocations under two beam conditions using a reflection of  $\vec{g} = [0002]$ . Because the dislocations (marked by arrows) are visible in this reflection condition, based on the invisibility criterion of  $\vec{g} \cdot \vec{B} = 0$ , the dislocations must be non-basal  $\langle \vec{a} + \vec{c} \rangle$  type with Burgers vector of  $\frac{1}{3} < 11\overline{2}3$ ].



*Fig.* 14 {0002} pole figures of recycled Ti-6Al-4V after one pass with a back-pressure of 250 MPa at temperatures of (a) 500 °C and (b) 550 °C.



Fig. 15 TEM iamges of dislocations in the sample processed at 550 °C with a back-pressure of 250 MPa after one pass, under two beam conditions using diffraction vector  $\vec{g} = [0002]$ .

#### 3. Conclusions

In the present study, the microstructural and texture evolution of recycled Ti-6AI-4V by using ECAP were investigated after multiple passes and at different temperatures. At the processing temperature of 500 °C, the microstructure is refined from elongated and coarser grains after a single pass to fully equiaxed and ultrafine grains after 8 passes. The shear deformation during ECAP leads to the formation of texture. The texture development after the first pass showed a strong B texture. The further increase of passes to 4 and 8 makes the c-axis rotate towards the TD and NID with 10° - 20° orientation spread due to the deformation by slips during the ECAP process using B<sub>c</sub> route. The increase in back pressure has no effect on the grain size and morphology of the ECAP processed samples, only the fibre texture is strengthened slightly with the increase in back pressure. The increase of the processing temperature by 50 °C resulted in the significant grain coarsening and the formation of oxide layer at the chip/chip interface. The fragmented oxide during ECAP may contribute to the improvement of microhardness.

Additionally, the c-axis were observed to rotate towards the LD because of the activation of the non-basal slip resulting  $\{0002\}$  // LD texture.

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